

MemoryS 2025

存储格局·价值重塑 MemoryS 2025 大会议程表

2025/03/12 中国·深圳 前海JW万豪酒店

时段	项目	演讲人	演讲主题
08:00-09:10	签到		
09:10-09:20	主持开场		
09:20-09:35	CFM	总经理 郜炜	存储格局 价值重塑
09:35-09:55	三星电子	软件开发团队执行副总裁 吴文旭	人工智能浪潮：重塑存储与内存的新需求格局
09:55-10:15	长江存储	市场负责人 范增绪	晶栈Xtacking——全面拥抱AI+时代存力需求
10:15-10:35	铠侠	首席技术执行官 柳茂知	后AI时代下的SSD市场愿景与关键技术
10:35-10:55	美光	集团副总裁 Dinesh Bahal	美光创新，加速边缘AI应用
10:55-11:15	闪迪	全球产品副总裁 Eric Spanneut	向新而行：系统方案应对现实挑战
11:15-11:35	高通	高级销售总监 陈心	骁龙X系列：引领智能计算新时代
11:35-11:55	Arm	物联网事业部业务拓展副总裁 马健	释放AI潜能：基于Arm构建从云到边的安全、高效AI计算平台
11:55-12:15	慧荣科技	终端与车用存储业务群资深副总裁 段喜亭	打破极限，赋能存储无限可能
12:15-12:35	Solidigm	亚太区销售副总裁 倪锦峰	加速存储创新 拥抱AI时代
12:35-13:30	午餐		
13:30-13:45	主持开场		
13:45-14:15	MemoryS 企业大奖		
14:15-14:35	英特尔	中国区技术部总经理 高宇	Intel平台DeepSeek解决方案
14:35-14:55	江波龙	董事长 蔡华波	存储商业 综合创新
14:55-15:15	群联电子	执行长 潘健成	NAND产业未来路在何方
15:15-15:35	联芸科技	董事长 方小玲	创新点滴，价值长河
15:35-15:55	宜鼎国际	嵌入式闪存事业部总经理 吴锡熙	智构未来
15:55-16:15	平头哥半导体	产品总监 周冠锋	做智能化时代更好的存储底座
16:15-16:35	腾讯云	OpenCloudOS社区TOC主席 王佳	破界·共生：OS生态下的软硬件创新融合
16:35-16:55	忆恒创源	CEO 张泰乐	极致存力，释放数据中心无限潜能
16:55-17:15	大普微	董事长 杨亚飞	为AI时代定义先进存储
17:15-17:35	小鹏汽车	嵌入式平台高级总监 段志飞	存储赋能AI汽车全面智能化
17:35-17:55	FADU	中国区总经理 康雷	先进架构设计助力AI时代存储
18:20-20:30	MemoryS Night (定向邀请)		

最终演讲嘉宾请以现场公布为准，主办方保留最终解释权

本届大会铂金赞助商

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MemoryS 2025

MEMORY LANDSCAPE VALUE RE-SHAPE MemoryS 2025 AGENDA

March 12, 2025 - JW MARRIOTT HOTEL SHENZHEN BAO'AN

TIME	ITEM	KEYNOTE SPEAKER	KEYNOTE TOPIC
08:00-09:10	Sign-in		
09:10-09:20	Opening		
09:20-09:35	CFM	CEO TaiWei	Memory Landscape, Value Reshape
09:35-09:55	Samsung	EVP of Software Development Team Moonwook Oh	The AI Revolution: Fueling New Demands for Memory and Storage
09:55-10:15	YMTC	Marketing Head Frank Fan	Xtacking—Embracing Memory Demands in the AI+ Era
10:15-10:35	Kioxia	Technology Executive Shigenori Yanagi	SSD Market vision and key technologies after AI era
10:35-10:55	Micron	Corporate Vice President Dinesh Bahal	Innovations at Micron accelerating AI adoption at the edge
10:55-11:15	Sandisk	VP of Global Product Management Eric Spanneut	Future Forward: System Level Innovation
11:15-11:35	Qualcomm	Senior Sales Director Chen Xin	Snapdragon X Series: Pioneering the New Era of Intelligent Computing
11:35-11:55	Arm	VP China GTM IoT & Embedded Chloe Ma	Unleashing AI Potential: Building Cloud-to-Edge Secure and Efficient AI Compute Platform on Arm
11:55-12:15	SiliconMotion	SVP of the Client & Automotive Storage business unit Nelson Duan	Break Boundaries, Unleash Infinite Memory Potential
12:15-12:35	Solidigm	Greater Asia Region Vice President of Sales Benny Ni	Accelerate Memory Innovation, Embrace the AI Era
12:35-13:30	Lunch		
13:30-13:45	Open show		
13:45-14:15	MemoryS Award		
14:15-14:35	Intel	GM,PRC Country Tech Enablement Group Gary Gao	DeepSeek Solutions on Intel Platform
14:35-14:55	Longsys	Chairman Cai Huabo	Memory Business, Comprehensive Innovation
14:55-15:15	PHISON	CEO K.S. Pua	Where is the Future of NAND Industry
15:15-15:35	Maxio	Chairman Fang Xiaoling	From Ripples of Ideas to Rivers of Value
15:35-15:55	Innodisk	GM of Embedded Flash Division C.C. Wu	Architech Intelligence
15:55-16:15	T-Head	Product Director Zhou Guanfeng	Building Superior Storage Foundations for the Intelligent Era
16:15-16:35	Tencent Cloud	OpenCloudOS Community TOC Chair Jasper Wang	Boundary Breaking · Symbiosis: Software - Hardware Innovation Integration in the OS Ecosystem
16:35-16:55	Memblaze	CEO Zhang Taile	Ultimate storage power, unleashing the infinite potential of data centers
16:55-17:15	DapuStor	Chairman Zhang Yafei	Defining Advanced Storage For AI
17:15-17:35	XPENG	Embedded Platform Department Senior Director Jeffery Duan	Storage Powers Full Intelligence in AI-Driven Vehicles
17:35-17:55	FADU	GM of China Region Kang Lei	Advanced Architecture Powering AI-Era Storage Performance
18:20-20:30	MemoryS Night (Directional Invitation)		

The final speakers are subject to the site announcement and the organizer reserves the right of final interpretation.

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